

# ILDC1x Ultraminiature Isolated DC-to-DC Convertors



## Block Diagram



# **Features**

- World's smallest isolated DC-DC convertor
- Ultraminiature 3 x 5.5 x 0.9 mm (0.015 cm<sup>3</sup>) DFN or 8 mm creepage SOIC16-WB
- 3.3 V input; 3.3 V, 5 V, or 6 V output options
- ¼ W output
- Fully-regulated output
- · Option for external regulators
- No minimum load
- Ultralow ripple
- · Low EMI without ferrite beads or inductors
- · Short-circuit and thermal protection
- 4 kV<sub>RMS</sub> isolation (2.5 kV<sub>RMS</sub> for DFN version)
- Full -40 °C to 125 °C operating range with no derating

## **Applications**

- Ground loop mitigation
- RS-485 / RS-422 bus power supplies
- Isolated SPI / Microwire interfaces
- Isolated ADC and DAC power supplies
- "2 x MOPP" medical systems requiring true 8 mm creepage

## **Description**

The ILDC1x family is ultraminiature one-quarter watt fullyregulated 3.3 V input DC-DC convertors that generate an independent, isolated 3.3-volt, 5-volt, or 6-volt supplies.

There are two package options—the ILDC1x-15E ultraminiature 3 mm x 5.5 mm DFN6, and the ILDC1xVE SOIC16W. The DFN version is the world's smallest isolated DC-DC convertor at just 0.015 cm<sup>3</sup>.

The device minimizes board space and parts count, requiring just three external capacitors. No additional regulation is required and there is no minimum load.

The DFN version is rated at a full 2.5  $kV_{RMS}$ , and the SOIC16 has a remarkable 4  $kV_{RMS}$  isolation rating.

A unique ceramic/polymer composite barrier provide virtually unlimited barrier life.

Internal shielding and frequency hopping reduce EMI and eliminate the need for ferrite beads.

A high-temperature process allows up to 175 °C junction temperature for full power up to 125 °C operating temperature with no derating. Integrated short-circuit protection avoids excessive power dissipation.



# Absolute Maximum Ratings

Parameter	Min.	Max.	Units
Supply voltage	-0.6	6	Volts
Storage temperature	-55	180	°C
Junction temperature	-55	180	°C

# **Recommended Operating Conditions**

Parameter	Symbol	Min.	Тур.	Max.	Units	Test Conditions
Ambient operating temperature	$T_{min}$ ; $T_{max}$	-40		125	°C	
Junction temperature	TJ	-40		175	°C	
Input supply voltage	V <sub>DD1</sub>	3	3.3	3.6	V	
Output current	I <sub>DD2</sub>	0		80	mA	

# **Electrical Specifications**

$T_{min}$ to $T_{max}$ and $V_{DD1} = 3$ V to 3.6 V unless otherwise stated						
Parameter	Symbol	Min.	Тур.	Max.	Units	<b>Test Conditions</b>
Output voltage ILDC11 ILDC12 ILDC13	V <sub>DD2</sub>	3 4.5 5.4	3.3 5 6	3.45 5.5 6.6	V	$T_{min}$ to $T_{max}$ ; full $V_{DD1}$ and $I_{DD2}$ operating range
Output current ILDC11 ILDC12 ILDC13	I <sub>DD2</sub>	80 50 41			mA	
Short-circuit protection limited current	Idd2-sc	115	125	135	mA	
Input quiescent supply current	I <sub>DD1Q</sub>		200	240	mA	$I_{DD2} = 0$
Input supply current ILDC11 ILDC12 ILDC13	I <sub>DD1</sub>		380 312 290	440 360 340	mA	$I_{DD2} = max.$
Line regulation	$\Delta V_{DD2}/\Delta V_{DD1}$		32 16	40	mV/V	25 °C 125 °C
Load regulation	$\Delta V_{DD2}/V_{DD2}$		5	6	%	$I_{DD2} = 0$ to max.
Output voltage temperature coefficient	$(\Delta V_{DD2}/V_{DD2})/\Delta T$		0.017 0.03		%/°C	$I_{DD2} = 10 \text{ mA}$ $I_{DD2} = 50 \text{ mA}$
Capacitive load	CDD2			1000	μF	
Output voltage ripple	N/	_	1	5		20 MHz bandwidth; $I_{DD2} = max.$
	V DD2RIPPLE		1		III <b>v</b> р-р	1 kHz bandwidth; $I_{DD2} = max.$
Start-up time	tau	2			ms	$I_{DD2} = 0$
	LSU			6	1115	$I_{DD2} = max.$
Convertor frequency	f <sub>OSC</sub>	105	113	120	MHz	



# **Thermal Specifications**

Parameter		Symbol	Min.	Тур.	Max.	Units	Test Conditions
Junction-to-ambient	ILDC1x-15E	ρ		46			2-2- DCD IESD51.
thermal resistance	ILDC1xVE	$0_{\rm JA}$		46			2s2p PCB per JESD31;
Junction-to-case (top)	ILDC1x-15E	Δ		12		°C/W	(if applicable); free air.
thermal resistance	ILDC1xVE	0 <sub>JC</sub>		9			
Junction-to-ambient	ILDC1x-15E	0		52.5			2-sided PCB with 2 oz
thermal resistance	ILDC1xVE	$\Theta_{JA}$		67		-	Cu and thermal vias; leadframe pad grounded.
Junction-to-case (top)	ILDC1x-15E	0		8			
thermal resistance	ILDC1xVE	0 <sub>JC</sub>		12			
Package power	ILDC1x-15E	р			1.5	W	
dissipation	ILDC1xVE	ſ			1.5	vv	

## **Isolation Specifications**

Parameter		Symbol	Min.	Тур.	Max.	Units	Test Conditions
I	ILDC1x-15E	V	2.5			$kV_{\text{RMS}}$	Per UL 1577 and
Isolation voltage	ILDC1xVE	V ISO	4				VDE 0884-17
Working voltage	ILDC1x-15E	V <sub>iorm</sub>	600			V	Dor VDE 0884 17
working voltage	ILDC1xVE		600			V <sub>RMS</sub>	Fel VDE 0884-17
Transiant averyaltage	ILDC1x-15E	V	4			1 - V	
Transfelit övervoltage	ILDC1xVE	V IOTM	6			K V PK	Per VDE 0884-17
Surge immunity			6.4			kV <sub>PK</sub>	
Creepage distance	ILDC1x-15E		3.5				Per IEC 60601
(external)	ILDC1xVE		8.03	8.3		111111	
Comparative tracking	ILDC1x-15E	CTI	≥175				$D_{0}$ IEC 60112
index	ILDC1xVE	CII	≥600			V <sub>RMS</sub>	Fel IEC 00112
Total barrier thickness (in	nternal)		0.012	0.016		mm	
Isolation barrier resistance	e	R <sub>IO</sub>		>10 <sup>14</sup>		Ω	500 V <sub>RMS</sub>
Isolation barrier capacitance		C <sub>IO</sub>		7		pF	f = 1 MHz
Leakage current				0.2		$\mu A_{RMS}$	240 V <sub>RMS</sub> , 60 Hz
Damian life				44000	44000	Vaama	100°C, 1000 V <sub>RMS</sub> , 60%
				44000		rears	CL activation energy

\*UL 1577 listed under Component Recognition Program File Number E207481.

ILDC1x-15E tested at 3  $kV_{RMS}$  (4.24  $V_{PK})$  for 1 second, 5 pC partial discharge limit in accordance with UL 1577 and VDE 0884-17 Method B1.

Each lot sample tested at 2.5  $kV_{RMS}\,(3.53\;V_{PK})$  for 1 minute.

ILDC1xVE tested at 4.8 kV<sub>RMS</sub> (6.79 kV<sub>PK</sub>) for 1 second, 5 pC partial discharge limit in accordance with UL 1577 and VDE 0884-17 Method B1.

Each lot sample tested at 4  $kV_{RMS}$  (5.66  $kV_{PK})$  for 1 minute.

- IEC 60601-1 (medical systems)
  - ILDC1x-15E is 1 x MOOP compliant (isolation voltage  $\geq$ 1.5 kV<sub>RMS</sub>; creepage  $\geq$ 2.5 mm).
  - ILDC1xVE is 2 x MOPP compliant (isolation voltage  $\ge$ 4 kV<sub>RMS</sub>; creepage  $\ge$ 8 mm).
- All versions compliant with IEC 60950-1 and IEC 62368-1 end equipment standards.



# **Features**

#### **Best-in-Class Isolation**

A unique ceramic/polymer composite barrier provides virtually unlimited barrier life. The DFN versions provide full 2.5  $kV_{RMS}$  isolation, and the wide-body SOIC version provides a remarkable 5  $kV_{RMS}$  and true eight-millimeter creepage in accordance with IEC60601.

#### Low Parts Count

The only external components required are three inexpensive bypass capacitors on the VDD1, VDD2, and VF pads. This low external parts count reduces board area and cost.

#### Fully Regulated with no Minimum Load

Unlike other DC-DC convertors, ILDC1x devices have fully-regulated outputs specified over the full input voltage and output current operating ranges. This eliminates the need for an external regulator or load resistor.

#### Ultralow Ripple

An inexpensive external filter capacitor (VF) and excellent line regulation and ensures the output ripple voltage is less than  $5 \text{ mV}_{P-P}$ .

#### Short-Circuit Protection

The output current is internally limited to approximately 125 mA. This provides short-circuit protection and eliminates the need for external protection circuitry.

#### Inherently Low EMI

The DC-DC convertor oscillator operates above 88 MHz, a much higher frequency than conventional DC-DC convertors, where emission limits are higher since there is less risk of interference with some common commercial radio and television broadcasting.

Frequency-hopping technology dramatically reduces peak EMI, and synchronous rectification and PWM control are avoided, resulting in inherently low EMI. Ferrite beads are not required for EMI mitigation.

This inherently low EMI allows CISPR and FCC compliance without external components or shielding.





## Operation

An ILDC1x block diagram is shown below:



Figure 1. ILDC1x detailed block diagram.

A 113 MHz oscillator drives a high-frequency power amplifier, which in turn drives an IsoLoop<sup>®</sup> microtransformer primary. Frequency hopping reduces EMI peak amplitudes, and embedded magnetic shielding further reduces radiated EMI.

On the other side of the isolation barrier, the transformer secondary output is filtered, rectified, and regulated by a low-EMI low dropout regulator with a precision bandgap voltage reference.

A high-temperature process allows up to 175 °C junction temperature for full power up to 125 °C operating temperature with no derating.



# Application Information

## Low Parts Count

The only external components required are three inexpensive bypass capacitors: a 0.1  $\mu$ F ceramic capacitor placed as close as possible to the VDD1 pad, a 10  $\mu$ F ceramic capacitor for the VDD2 pad, and a 0.1  $\mu$ F/16 V filter capacitor near the VF pad.

## Fully Regulated with no Minimum Load

The ILDC1x has a fully-regulated output specified over the full input voltage and output current operating ranges, eliminating the need for an external regulator or load resistor.

#### Soft Start-up

When used in MOSFET gate drivers or H-bridges, the 2 ms minimum startup time allows the control electronics to start up before the MOSFETs can be turned on to ensure high- and low-side MOSFETs on the same side are not on at the same time.

#### **Optional External Regulation**

An external regulator can be used in place of the ILDC1x's internal low drop-out regulator for voltages up to approximately 7.5 volts. The maximum output current decreases at higher regulator output voltages, but the output power capacity remains approximately 250 milliwatts.

## EMI Mitigation

Electromagnetic compatibility is regulated by international standards such as IEC 61000-4-x and CISPR 32. Although systemlevel performance depends on board design and layout, ILDCx parts incorporate embedded magnetic shielding to reduce radiated EMI and frequency hopping to reduce EMI peak amplitudes. This inherently low EMI generally eliminates the need for ferrite beads or other EMI mitigation.

#### No Temperature Derating

A double sided, double buried power plane ("2s2p") printed-circuit board optimizes thermal performance, allowing full power up to 125 °C operating temperature with no derating. Thermal vias should be used between the power plane and the board surfaces. Both input-side ground pads and the leadframe pad (for the DFN package) should be grounded using wide traces to help cool the leadframe.

At the full output current with the recommended PCB, the ILDC1x dissipates approximately one watt and the resultant junction temperature rise is 46 °C for either package, so at 125 °C ambient the junction temperature is less than the 175 °C maximum junction temperature.

A simple double-sided PCB with thermal vias can be used rather than a 2s2p PCB with some derating (see Figure 6).

## Maintaining Creepage

Creepage distances are often critical in isolated circuits. Therefore, power planes should be spaced to avoid compromising creepage or clearance, and board pads should not extend past the part pads to avoid compromising clearance.

#### Medical Systems

Patient-applied parts electrically connected to the patient in body-floating medical systems generally require two Means Of Patient Protection (2 x MOPP). ILDC1xVE parts meet the 2 x MOPP requirements of 4 kV<sub>RMS</sub> isolation and true 8 mm creepage. AC/DC power supplies meeting these requirements are difficult to find and expensive. An inexpensive 2 x MOOP power supply can supply the operator interface, while a 2 x MOPP compliant ILDC1xVE DC-to-DC converter can power the patient-applied electronics. The power requirements of the patient-applied electronics are generally low and can be satisfied with an ILDC1xVE. A typical circuit is shown in Figure 22.



## **Typical Performance Graphs**



vs. temperature and self-limiting current.

Figure 7. Temperature derating curve (ILDC11).





Figure 8. Typical unregulated output voltage versus output current (V\_{DD1} = 3.3 V; 25  $^{\circ}C$ ).



Figure 9 Typical DC-to-DC convertor start-up voltage (no load).



Figure 11. Typical DC-to-DC convertor start-up voltage (IL46xx; maximum load).



Figure 10. Typical DC-to-DC convertor start-up current (no load).



Figure 12. Typical DC-to-DC convertor start-up current (maximum load).





# **Typical Applications**

Typical isolated RS-485 bus power supply and node:



Figure 13. An isolated 3.3-volt RS-485 bus supply and node.

An isolated 3.3 volt bus supply is generated from the controller supply. The ILDC11 generates enough power for an RS-485 bus and termination resistors.





#### Isolated controller supply from a 3.3-volt bus:



Figure 14. Reversed configuration: isolated controller supply from a 3.3-volt bus.

Normally the bus supply is generated from the controller supply, but the reverse is also possible. An advantage of this configuration is that since the DC-DC convertor does not need to supply the bus-side power, the bus can have two  $120\Omega$  termination resistors with the transceiver running at maximum speed, a combination that would exceed the ILDC11's maximum output current if it were powering the bus. The ILDC11 generates enough power to supply a microcontroller and other circuitry in addition to a transceiver.





# Isolated SPI sensor interface:



Figure 15. An isolated SPI sensor interface.

Isolation reduces noise by eliminating ground loops, and improves safety by providing another insulation level. The ILDC11 generates an isolated power supply to independently power the sensor. The four-channel IL717 isolator transmits the SPI signals while maintaining galvanic isolation. A five-channel IL261 isolator can be used to select between two sensors A similar circuit can be used for a variety of four-wire interface sensors, including angle, magnetic field, current, temperature, or pressure sensors.





# Isolated SPI / MICROWIRE ADC interface:



Figure 16. Isolated ADC serial interface.

An isolated analog power supply generated by the ILDC11 significantly improves the noise performance of a successiveapproximation ADC. The three-channel IL814TE isolates the ADC's serial interface. A similar circuit can be used for other threewire SPI or MICROWIRE peripherals such as DACs or sensors.



## External regulator for nonstandard voltages:



Figure 17. A 3.3-volt input / adjustable output isolated supply using an external regulator.

An inexpensive adjustable low-dropout regulator can be added to the ILDC11's VF output to provide nonstandard output voltages.

5-volt input:



Figure 18. A 5-volt input / 3.3-volt output isolated supply.

An inexpensive chip-scale linear regulator such as an NCP161 can be used for a 5-volt input.





A step-down (buck) switching regulator can be used with a 5-volt input for higher efficiency than a linear regulator.



# Isolated 12-volt output:



Figure 20. A 3.3-volt input / 12-volt output isolated supply.

An inexpensive boost regulator can be added to an ILDC1x to provide an isolated 12-volt output. The ILDC1x's inherent stability allows it to directly drive the inductive load required for the boost regulator.



## Isolated 5-volt bus system:



5-Volt Isolated Transceivers							
Model	Duplex	Inputs	Mbps	Nodes	<b>Bus ESD</b>	Key Features	Available Packages
IL3022	Full	Digital	4	32	7.5 kV	Low Cost	0.3" SOIC16
IL2985	Half	Digital	4	32	15 kV	Low Power	0.3" SOIC16
IL3085	Half	Digital	4	32	15 kV	Low Cost	QSOP16; 0.15" SOIC16; 0.3" SOIC16
IL3522	Full	Digital	40	50	15 kV	Very High Speed	0.3" SOIC16
IL3585	Half	Digital	40	50	15 kV	Very High Speed	0.15" SOIC16; 0.3" SOIC16
IL3685	Half	Digital	40	50	15 kV	PROFIBUS	QSOP16; 0.15" SOIC16; 0.3" SOIC16

## Figure 21. An isolated 5-volt RS-485 bus system.

An ILDC12 provides isolated five volts for a traditional RS-485 bus. The ILDC12's output capacity is 50 mA, which is enough to power an RS-485 transceiver without termination resistors. It can also power a number of additional low-power nodes if desired. Low-power IL2985 transceivers have a maximum bus-side quiescent supply current of less than 2 mA. Other 5-volt isolated transceiver options include the 40 Mbps IL3585, the 40 Mbps PROFIBUS IL3685, the low-cost IL3085, and the full-duplex IL3522 or IL3022. Ultraminiature IL3685-1E or IL3085-1E QSOP16 versions are available to minimize board area.



# Isolated H-Bridge Drivers:



Figure 22a. Simple isolated H-bridge.

Four channels of isolation in three IL6xxCMTI isolators allow referencing the high-side gate signals to the floating MOSFET source pins, plus they level-shift low-voltage controller inputs to six volts to drive MOSFET gates. These isolators have low-impedance outputs to directly drive low- to medium-power MOSFETs, so separate MOSFET drivers are not required.

The IL600CMTI isolators are the world's smallest isolators, with the highest common-mode transient immunity in the industry. With up to  $350 \text{ kV}/\mu\text{s}$  guaranteed transient immunity, the IL610CMTIs prevent spurious isolator switching when the high-side MOSFETs switch.

The ILDC13 isolates and floats the high-side gate power.

The isolator inputs on each side of the H-bridge are connected in series, which minimizes the time that two MOSFETs on the same side are both ON ("shoot-through"). When the DIR and  $\overline{\text{DIR}}$  inputs are high impedance, such as when a controller is starting up, all of the MOSFETs will be off.

If the DIR and  $\overline{\text{DIR}}$  inputs are both set low, the motor is grounded to shunt the back EMF and stop the motor.





Figure 22b. Isolated H-bridge with separate MOSFET control inputs.

This circuit provides separate inputs for each MOSFET to maximize flexibility, and allows all MOSFETS to be turned off while changing direction to prevent shoot-through.

The Schottky /conventional diode pairs ensure all MOSFETs are off when the MOSFET control inputs are tristate as the controller powers up.



ILDC1x Isolated DC-DC Convertors



Figure 22c. Isolated H-bridge with enhanced controller interface.

The addition of the DG2788 analog switch in Figure 19 provides PWM, Enable, and Direction inputs for a simple interface to the controller. It also allows the MOSFETs to be disabled during a reversal to prevent MOSFET shoot-through.

The LM317 regulator allows the isolators to be powered from a motor supply of up to 40 volts.





Figure 22d. Isolated high-power silicon-carbide H-bridge.

Silicon-carbide MOSFETs usually require more than six-volt gate drive and lower-impedance drivers. For these applications, IL610CMTI isolators can be combined with external drivers such as the IX4310T as shown in Figure 19. The separate gate drivers translate the IL611CMTI isolator outputs to nine volts and provide instantaneous high gate-drive currents for fast switching speeds with large MOSFETs.

The ILDC12's unregulated VF output provides approximately nine volts to power the high-side MOSFETs.



# Medical System Isolation:



Figure 23. Medical system isolation.

Combining a double Means Of Operator Protection (2 x MOOP) power supply with a double Means of Patient Protection (2 x MOPP) ILDC1xVE provides cost-effective compliance with IEC 60601 for body-floating medical systems. The power requirements of the patient-applied electronics are generally low and can be satisfied with an ILDC1xVE.





# **Evaluation Boards**



# ILDC1x-15E-01 and ILDC1xVE-01 Series Evaluation Boards

These boards use a 2s2p PCB with thermal vias for optimal thermal performance. The 1.75 by 1.75 inch (45 by 45 mm) boards have an ILDC-Series part plus the three required external bypass capacitors as well as LEDs to show the DC-to-DC convertor is operating. Screw terminals provide easy connections.

Versions are available with any of the ILDC-Series parts.



# ILDC1x-15E (3 mm x 5.5 mm DFN6 Package)



Notes:

Dimensions in millimeters.Soldering profile per JEDEC J-STD-020C, MSL 1.

RoHS COMPLIANT



# ILDC1xVE (SOIC16 Wide-Body Package)



Dimensions in inches (mm); scale = approx. 5X





# ILDC1x-15E Recommended Layout Footprint



## ILDC1xVE Recommended Layout Footprint





# Dimensions in inches (millimeters)



# Ordering Information ILDC1x-15E TR7

# Product Line

IL = Isolation products

Product Family DC = DC-DC convertor

# **Part Numbers**

**11** = 3.3 V in / 3.3 V out **12** = 3.3 V in / 5 V out **13** = 3.3 V in / 6 V out

# Part Package

15 = 3 x 5.5 mm DFN packageV = SOIC16 high-voltage wide-body package

# **RoHS-compliance**

 $\mathbf{E} = \text{RoHS-compliant}$ 

# **Bulk Packaging**

Blank = Bulk (tubes) **TR7** = 7" Tape and Reel **TR13** = 13" Tape and Reel

Part Number	Package	Voltage	Voltage	
ILDC11VE	SOIC16W	221/	221/	
ILDC11-15E	DFN6	3.3 V	3.3 V	
ILDC12VE	SOIC16W	221/	БV	
ILDC12-15E	DFN6	3.3 V	5 v	
ILDC13VE	SOIC16W	221	εV	
ILDC13-15E	DFN6	3.3 V	οv	

Available Parts.

ILDC1x Isolated DC-DC Convertors

Input

Output





# **Revision History**

ISB-DS-001-ILDC1x-RevH	Change
March 2023	• Updated H-bridge application circuits (Figs. 22a – 22d).
ISB-DS-001-ILDC1x-RevG Sept. 2022	<ul> <li>Changes</li> <li>Reduced startup current (p. 2).</li> <li>Received UL approval (p. 3).</li> <li>Changed isolation voltage from 5 kV to 4 kV under the more stringent IEC60747-17 standard.</li> <li>Added IEC 60601 medical equipment standards (p. 3).</li> <li>Added equipment-level safety standards such as IEC 62368-1 (p. 3).</li> <li>Added section on EMI mitigation (p. 6).</li> <li>Added section on medical systems (p. 6).</li> <li>Changed start-up description with soft-start on lot numbers 22xxxx and higher.</li> <li>Changed Fig. 9 for soft-start.</li> <li>Added diagram for medical system isolation (Fig. 22).</li> </ul>
ISB-DS-001-ILDC1x-RevF April 2021	<ul> <li>Changes</li> <li>Added 5 V and 6 V output options (ILDC12 and ILDC13).</li> <li>Added a wide-body SOIC16 version with 5 kV<sub>RMS</sub> isolation (ILDC1xVE).</li> <li>Updated isolation specifications (p. 3).</li> <li>Discontinued the 5 V bus demo board with an external regulator since we now offer a 5 V output DC-DC convertor version.</li> </ul>
ISB-DS-001-ILDC11-RevE Oct. 2020	<ul> <li>Changes</li> <li>Added VF vs. output current typical performance graph (Figure 8).</li> <li>Added descriptions of external regulator options.</li> <li>Revised external regulator reference designs and isolated H-bridge driver.</li> </ul>
ISB-DS-001-ILDC11-RevD	Change
Sept. 2020	• More detailed Figure 18 (isolated H-bridge driver).
ISB-DS-001-ILDC11-RevC July 2020	<ul> <li>Changes</li> <li>Added start-up current specification (p. 2) and typical graph (Figure 10).</li> <li>Added thermal protection description (p. 2) and typical graph (Figure 10).</li> <li>Updated step-down regulator reference design with higher-current regulator (Figure 16).</li> </ul>
ISB-DS-001-ILDC11-RevB June 2020	<ul><li>Change</li><li>Added efficiency performance graph (Figure 5).</li></ul>
ISB-DS-001-ILDC11-RevA June 2020	<ul> <li>Changes</li> <li>Finalized performance graphs.</li> <li>Changed package description from QFN to DFN.</li> <li>Additional application circuits.</li> <li>Initial release.</li> </ul>



#### Datasheet Limitations

The information and data provided in datasheets shall define the specification of the product as agreed between NVE and its customer, unless NVE and customer have explicitly agreed otherwise in writing. All specifications are based on NVE test protocols. In no event however, shall an agreement be valid in which the NVE product is deemed to offer functions and qualities beyond those described in the datasheet.

#### Limited Warranty and Liability

Information in this document is believed to be accurate and reliable. However, NVE does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NVE be liable for any indirect, incidental, punitive, special or consequential damages (including, without limitation, lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

#### **Right to Make Changes**

NVE reserves the right to make changes to information published in this document including, without limitation, specifications and product descriptions at any time and without notice. This document supersedes and replaces all information supplied prior to its publication.

#### Use in Life-Critical or Safety-Critical Applications

Unless NVE and a customer explicitly agree otherwise in writing, NVE products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical devices or equipment. NVE accepts no liability for inclusion or use of NVE products in such applications and such inclusion or use is at the customer's own risk. Should the customer use NVE products for such application whether authorized by NVE or not, the customer shall indemnify and hold NVE harmless against all claims and damages.

#### Applications

Applications described in this datasheet are illustrative only. NVE makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NVE products, and NVE accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NVE product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customers. Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NVE does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customers. The customer is responsible for all necessary testing for the customer's applications and products using NVE products in order to avoid a default of the applications and the products or of the application or use by customer's third party customers. NVE accepts no liability in this respect.

#### Limiting Values

Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the recommended operating conditions of the datasheet is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

#### **Terms and Conditions of Sale**

In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NVE hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NVE products by customer.

#### No Offer to Sell or License

Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

#### **Export Control**

This document as well as the items described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

#### **Automotive Qualified Products**

Unless the datasheet expressly states that a specific NVE product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NVE accepts no liability for inclusion or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NVE's warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NVE's specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NVE for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NVE's standard warranty and NVE's product specifications.



<お問い合わせ先>
日本代理店
株式会社ロッキ ISO9001、ISO14001認証取得
本社:東京都新宿区上落合1-16-7NKビル2F
TEL:03-6804-1411
MAIL: info@kkrocky.com
WEB: www.kkrocky.com
営業所:大阪前橋

本仕様の内容は、予告なく変更されることがあります。 最新のカタログはNVE社のホームページ(<u>www.nve.com</u>)よりダウンロード できます。

**©NVE** Corporation

**NVE** Corporation

www.nve.com

11409 Valley View Road

Telephone: (952) 829-9217

e-mail: iso-info@nve.com

An ISO 9001 Certified Company

Eden Prairie, MN 55344-3617 USA

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

ISB-DS-001-ILDC1x

March 2023